# 2SD1277, 2SD1277A

# Silicon NPN triple diffusion planar type Darlington

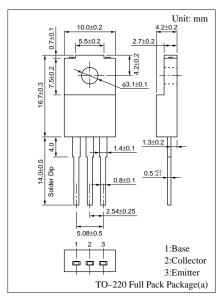
For midium speed power switching Complementary to 2SB0951 (2SB951) and 2SB0951A (2SB951A)

### Features

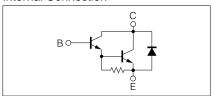
- High foward current transfer ratio h<sub>FE</sub>
- High-speed switching
- Full-pack package which can be installed to the heat sink with one screw

# Absolute Maximum Ratings (T<sub>C</sub>=25°C)

Parameter		Symbol	Ratings	Unit	
Collector to	2SD1277	V	60	V	
base voltage	2SD1277A	$V_{CBO}$	80		
Collector to	2SD1277	37	60		
emitter voltage	2SD1277A	$V_{CEO}$	80	V	
Emitter to base voltage		$V_{EBO}$	7	V	
Peak collector current		$I_{CP}$	12	A	
Collector current		$I_{C}$	8	A	
Collector power	T <sub>C</sub> =25°C	D	45	W	
dissipation	Ta=25°C	$P_{C}$	2		
Junction temperature		T <sub>j</sub>	150	°C	
Storage temperature		$T_{\rm stg}$	-55 to +150	°C	



#### Internal Connection



# Electrical Characteristics (T<sub>C</sub>=25°C)

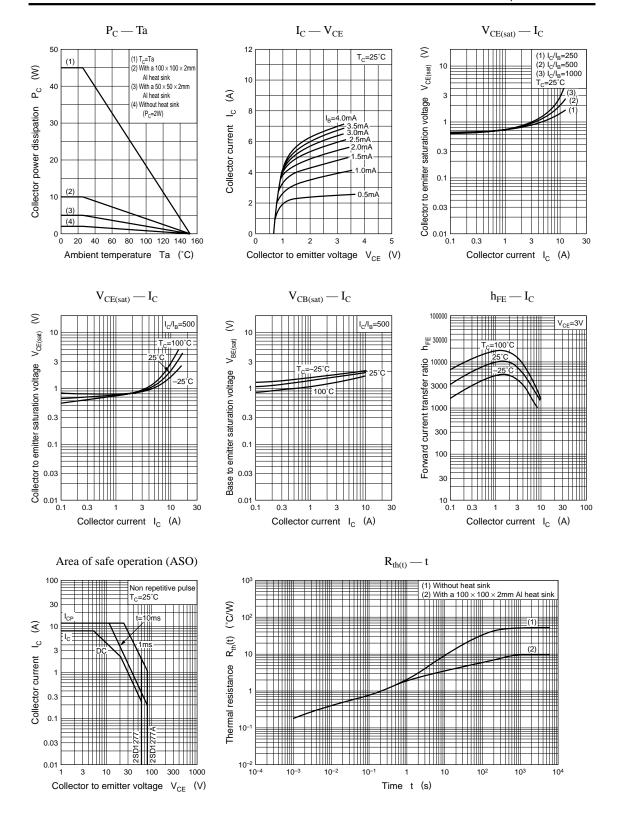
Parameter		Symbol	Conditions	min	typ	max	Unit	
Collector cutoff	2SD1277	т	$V_{CB} = 60V, I_E = 0$			100		
current	2SD1277A	I <sub>CBO</sub>	$V_{CB} = 80V, I_{E} = 0$			100	μΑ	
Emitter cutoff current		I <sub>EBO</sub>	$V_{EB} = 7V, I_{C} = 0$			2	mA	
Collector to emitter	2SD1277	***	$I_C = 30mA, I_B = 0$	60			V	
voltage	2SD1277A	V <sub>CEO</sub>		80				
Forward current transfer ratio		h <sub>FE1</sub> *	$V_{CE} = 3V$ , $I_C = 4A$	2000		10000		
		h <sub>FE2</sub>	$V_{CE} = 3V, I_{C} = 8A$	500				
Collector to emitter saturation voltage		V <sub>CE(sat)</sub>	$I_C = 4A, I_B = 8mA$			1.5	V	
Base to emitter saturation voltage		V <sub>BE(sat)</sub>	$I_C = 4A, I_B = 8mA$			2	V	
Transition frequency		$f_T$	$V_{CE} = 10V, I_C = 0.5A, f = 1MHz$	20			MHz	
Turn-on time		t <sub>on</sub>	$I_C = 4A, I_{B1} = 8mA, I_{B2} = -8mA,$ $V_{CC} = 50V$		0.5		μs	
Storage time		t <sub>stg</sub>			4		μs	
Fall time		t <sub>f</sub>			1		μs	

### \*h<sub>FE1</sub> Rank classification

Rank	Q	P
$h_{FE1}$	2000 to 5000	4000 to 10000

Note) The part numbers in the parenthesis show conventional part number.

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